

3D Silicon Pixel Detectors for the Forward Physics Experiments

PRELIMINARY Results

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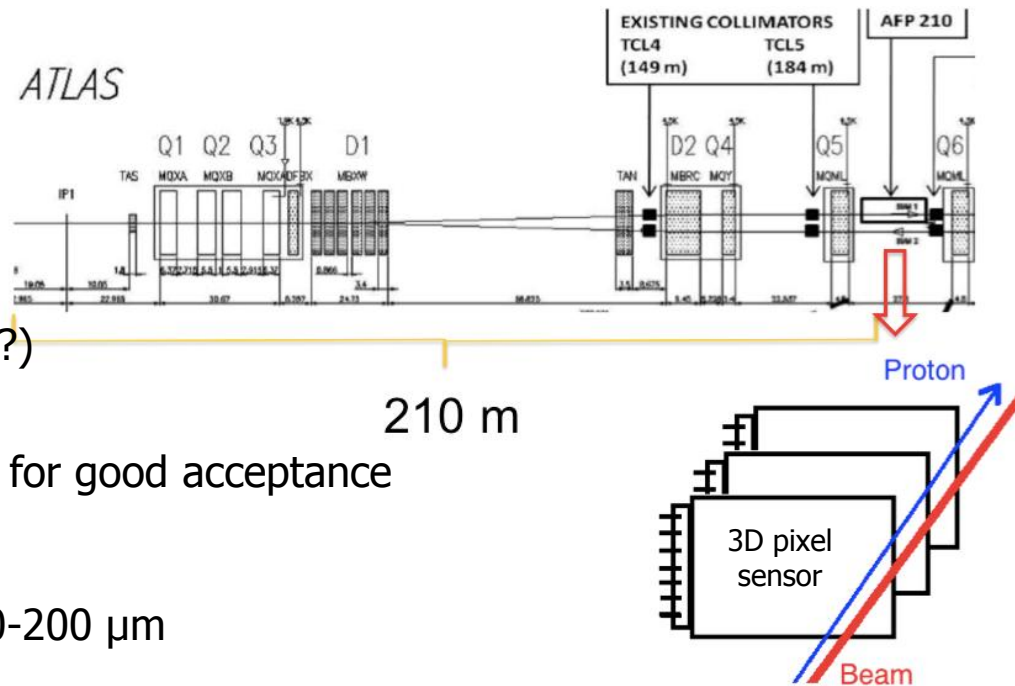
24th RD50 Workshop Bucharest 13.06.2014



Introduction

■ Atlas Forward Physics (AFP)

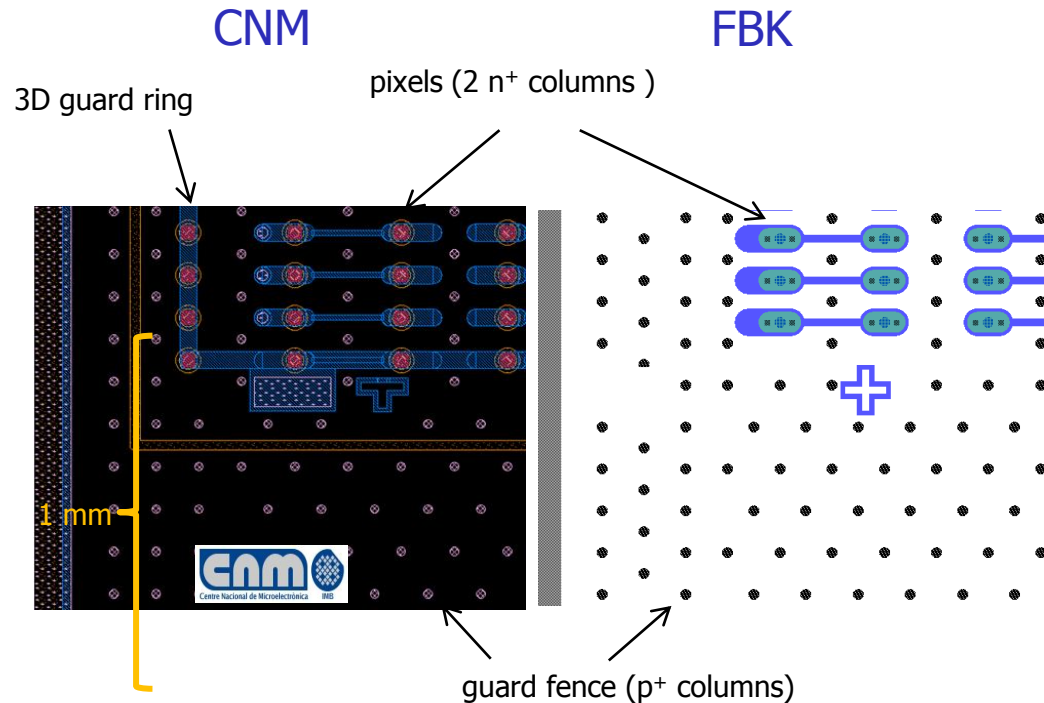
- Diffractive physics: protons leave pp interaction intact
→ **very forward protons**
- Combination of 3D pixel tracker and fast timing (UFSD?) detectors for pile-up removal
- **Detectors close to the beam** (2-3 mm) for good acceptance
- → Requirements:
 - **Slim edge** of side facing beam: $\sim 100\text{-}200\ \mu\text{m}$
 - **Highly non-uniform irradiation**
- Status of the proposal
 - **AFP conditionally approved** for dedicated low-lumi runs
 - Possible high-lumi upgrade later
 - Installation planned for end of 2015
→ **second use of 3D silicon sensors in HEP experiment!**



Sensors and Edge Slimming

- FE-I4 3D IBL sensors (CNM and FBK)

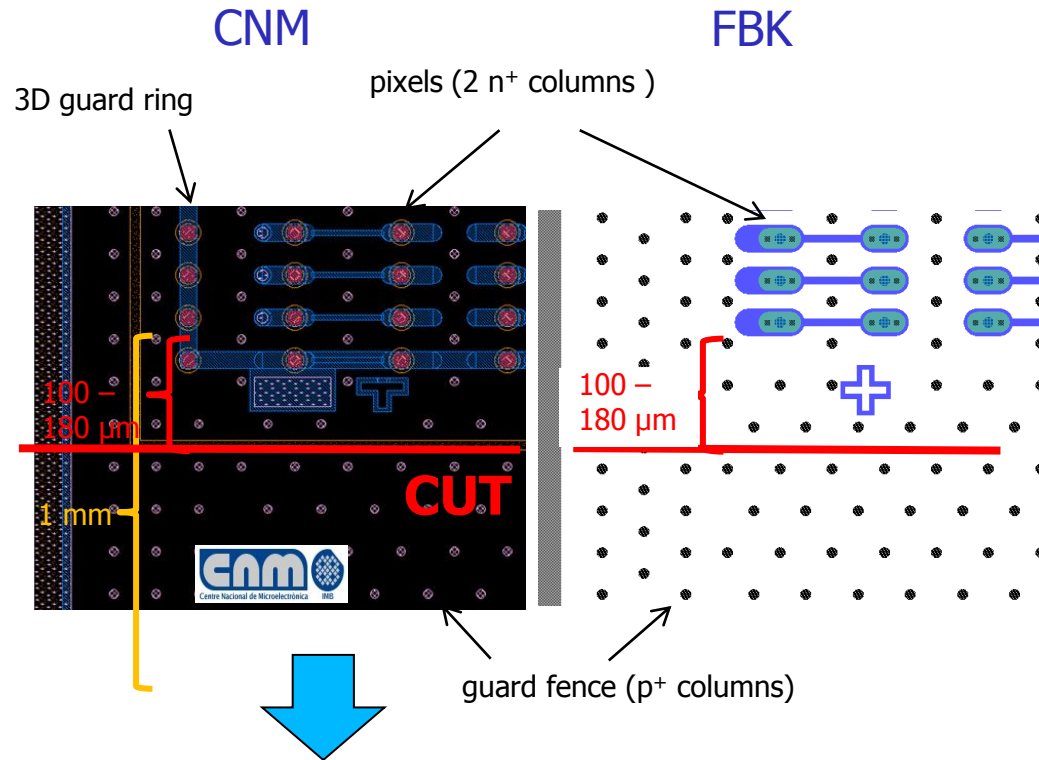
- 336x80 pixels of $50 \times 250 \mu\text{m}^2$
- p-type bulk, 2 n^+ columns per pixel
- Edge termination:
 - CNM: 3D guard ring of n^+ columns + p^+ ohmic-column fence
 - FBK: p^+ ohmic-column fence
 - Left/right already 200 μm slim edge
 - Bottom: >1 mm bias tab (not needed!)
- IBL spares (not always best quality)



Sensors and Edge Slimming

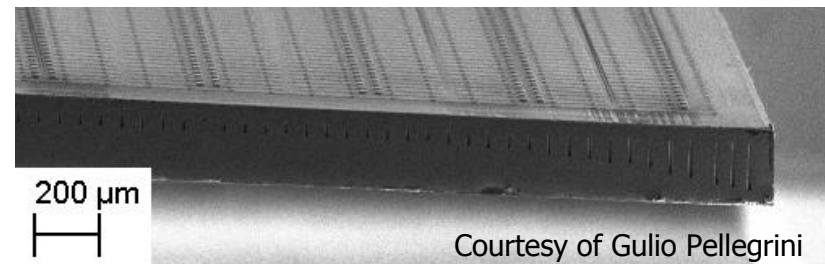
FE-I4 3D IBL sensors (CNM and FBK)

- 336x80 pixels of $50 \times 250 \mu\text{m}^2$
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- IBL spares (not always best quality)



Edge slimming:

- Cut IBL sensors' inactive bottom edge** down to $100\text{-}180 \mu\text{m}$ (FE-I4 chip: $80 \mu\text{m}$ dead region)
- Technique here: standard **diamond-saw cut**

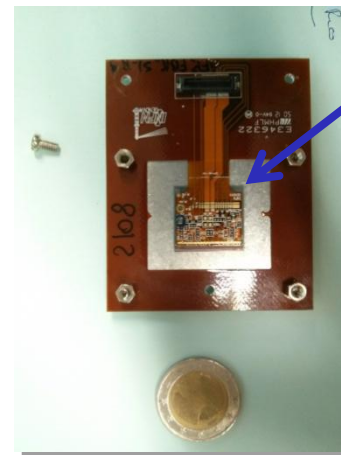
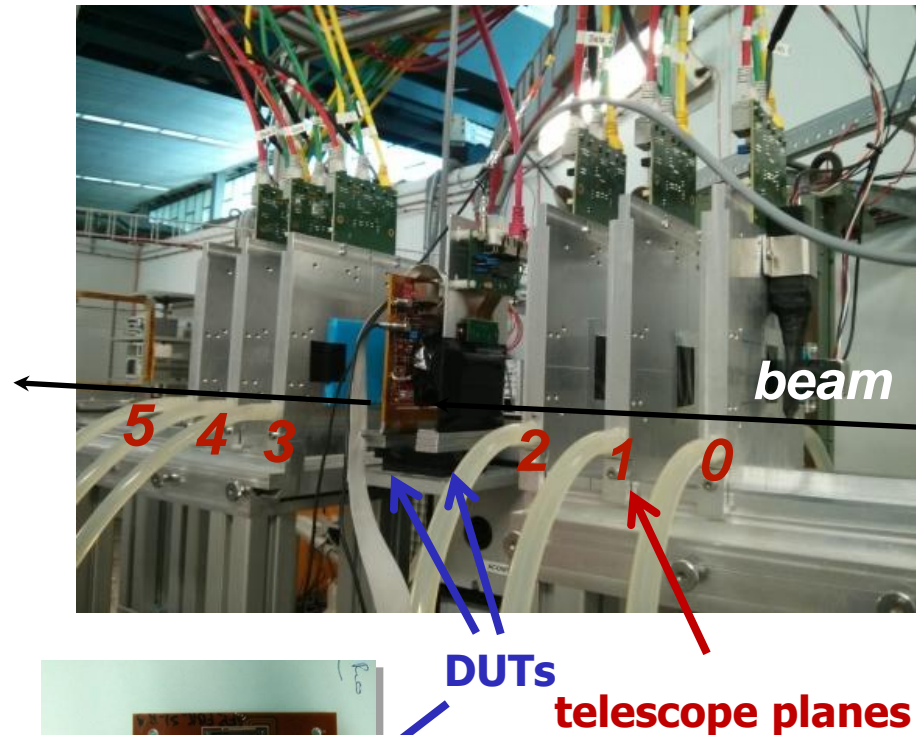


DESY Test Beam

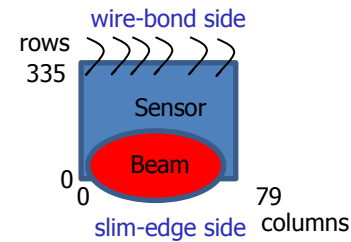
- Check performance in test beam
 - DESY II 4 or 5 GeV electrons
 - ACONITE telescope (EUDET type)
 - 6 planes of MIMOSA-26:
660k Si pixels (18.4 μm pitch)
 - Trigger: 4 scintillators
- Thanks to AIDA support



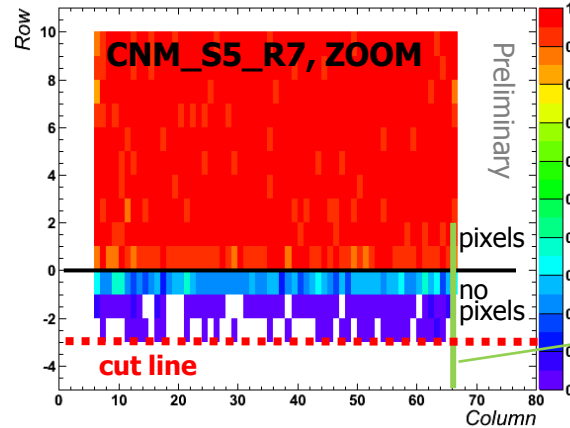
Thanks to all test beam participants,
esp. I. Rubinskiy (DESY), D. Pohl (Bonn),
O. Korchak (Prague), Sh. Hsu (Washington),
A. Micelli (IFAE)



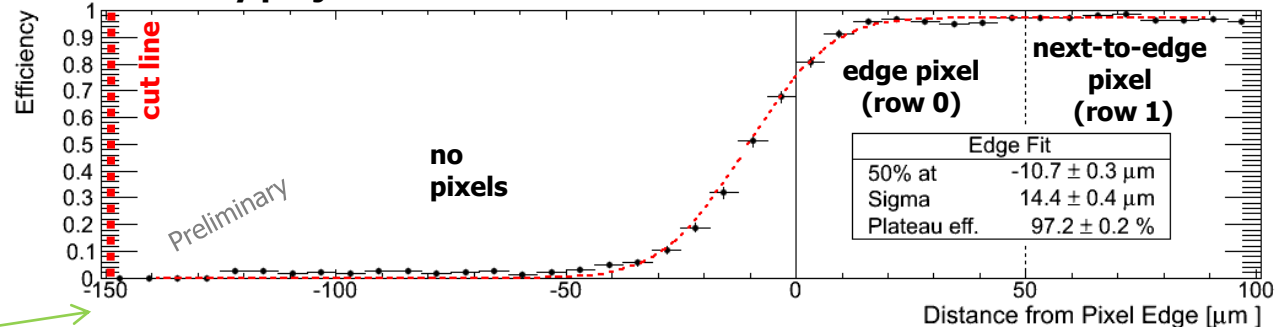
Slim-Edge Efficiency in DESY Test Beam



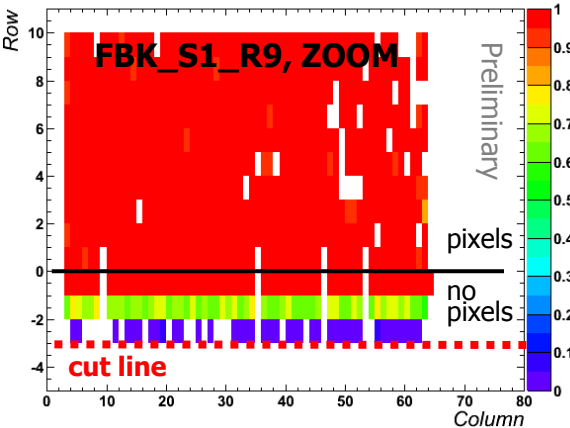
Y Edge Efficiency Sensor Map Bottom



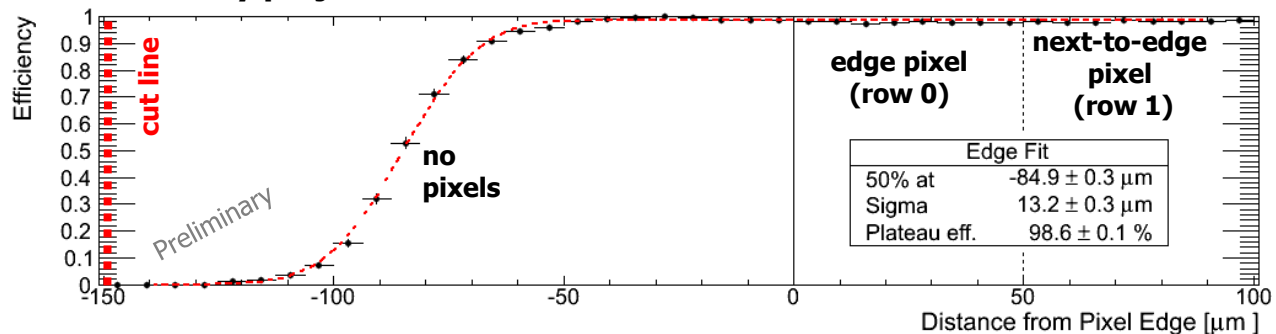
Efficiency projection CNM



Y Edge Efficiency Sensor Map Bottom



Efficiency projection FBK

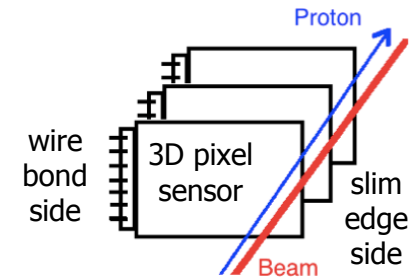


20 V bias

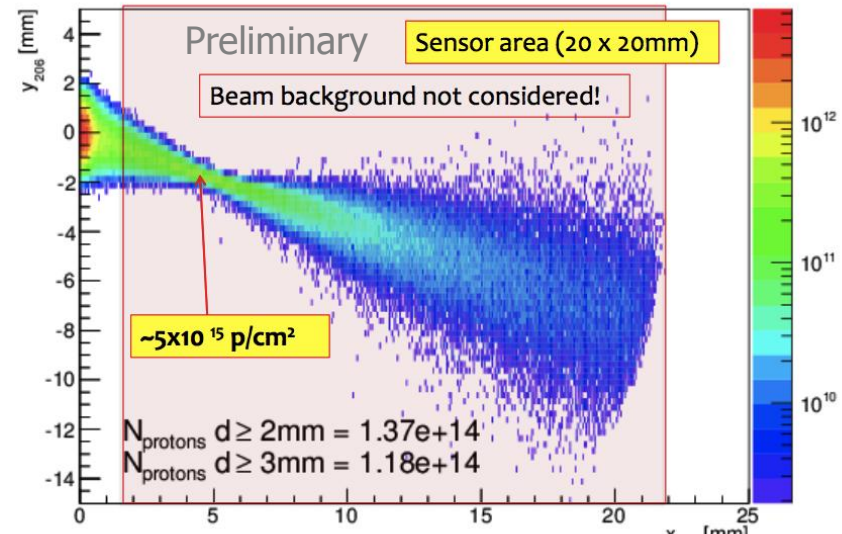
- Efficiency stable up to last pixel (Bug fixed compared to last RD-50 WS)
- For FBK even $\sim 80 \mu\text{m}$ beyond: Efficient edge due to absence of guard ring (but implications on resolution/alignment if edge pixel is different)
- In both cases: AFP slim-edge requirements fulfilled ($< 180 \mu\text{m}$ dead area)

Radiation Hardness Requirements

- Highly non-uniform irradiation
→ high fluence gradient between neighbouring pixels
- Integrated fluence depends on run scenario
- Low- μ run scenario (approved AFP scenario for start)
 - Only dedicated runs → $\sim 100 \text{ pb}^{-1}$
 - Fluence peak: $5 \times 10^{12} \text{ p/cm}^2$ ($\sim 7 \text{ TeV p}$)
→ should be manageable
- High- μ run scenario (possible future scenario)
 - In the beam for large parts of run 2 → $\sim 100 \text{ fb}^{-1}$
 - Fluence peak: $5 \times 10^{15} \text{ p/cm}^2$ ($\sim 7 \text{ TeV p}$)
→ studied in the following
- To check:
 - Can detector be operated to give high efficiency in all regions?
 - Unirradiated: Low $V_{\text{BD}} \rightarrow V < V_{\text{BD}}$ needed
 - Irradiated region: High V needed ($V > V_{\text{dep,irr}}$, E field)



Estimated Fluence for high- μ run:
of protons per 100 fb^{-1} / pixel ($50 \mu\text{m} \times 250 \mu\text{m}$)

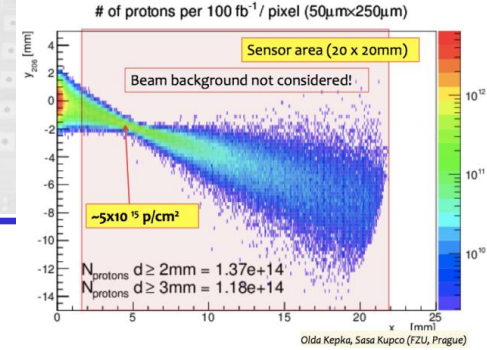


Olda Kepka, Sasa Kupco (FZU, Prague)

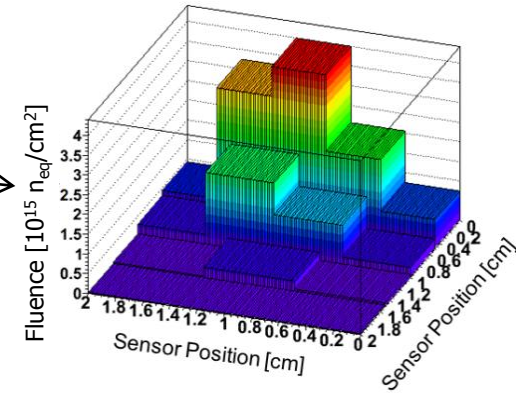
Non-Uniform Irradiation

- No 7 TeV irradiation facility available yet...
 - Radiation damage of 7 TeV p not yet calculated. Similar to GeV p?
Maybe should be studied within RD50? (important for all forward exp.)
 - Here: Proof-of-principle tests at usual irradi. facilities with lower p energy
- First test beam study in 2012 with focussed CERN-PS 23 GeV irradiation
see A. Micelli, 21st RD50 workshop Nov 2012; S. Grinstein, 8th Trento workshop 2013
- But fluence spread was large
- Another irradiation with more localised fluence:
23 MeV protons (KIT) through hole in Al plate (5 mm thick)

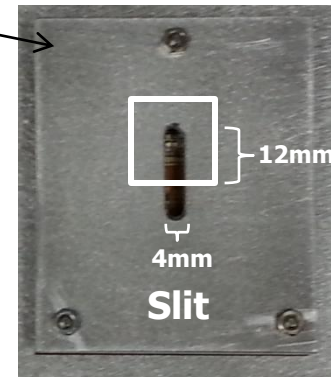
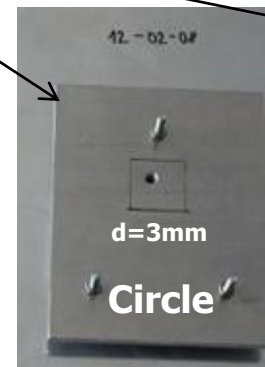
Thanks to Felix Bögelspacher (KIT) for irradiation and Petr Sicho (CERN) for help



Fluence map of CERN-PS irradiation:



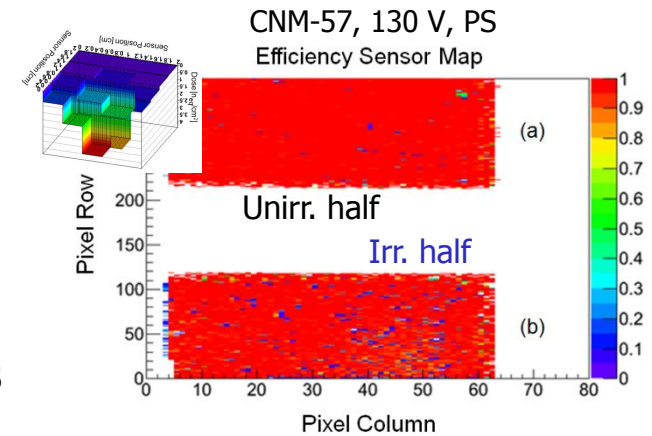
Al shields at Karlsruhe:



Non-Uniform Irradiation	PS 23 GeV p Focussed beam	KIT 23 MeV p Hole (circle)	KIT 23 MeV p Hole (slit)	
Φ [10 ¹⁵ n _{eq} /cm ²]	4.0 (max)	1.8	3.3	3.6
Sample	CNM 57	FBK 12_02_08	CNM S5-R7	CNM S3-R5
Edge	Regular	Regular	Slimmed	Slimmed

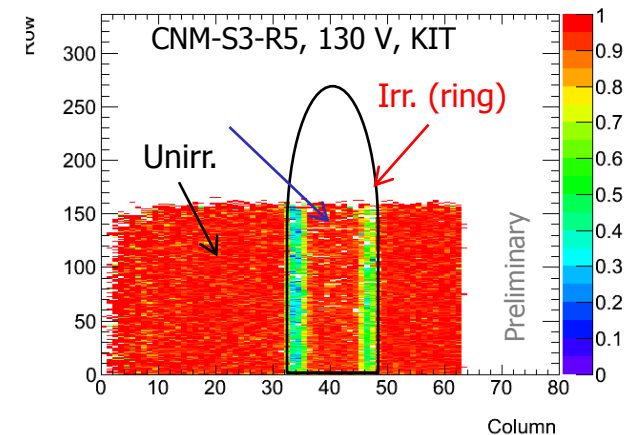
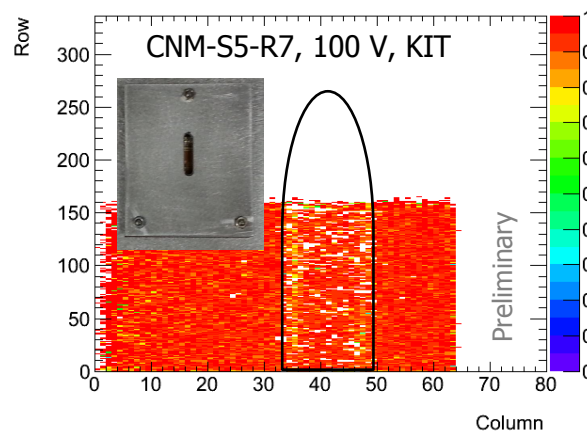
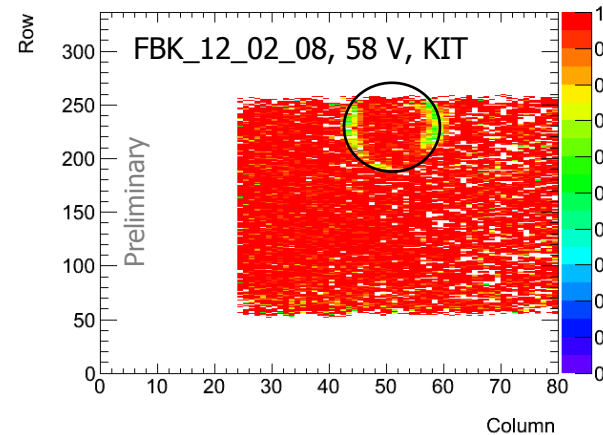
Efficiency of Irradiated Devices

- Test beam: DESY (KIT irr. devices), CERN (PS irr. device), normal incidence, $T < -20 \text{ }^\circ\text{C}$
- Different runs at different bias voltages of irradiated sample (V limited by high I_{leak})
- Irradiated area (only centre for KIT) almost as efficient as unirradiated region
- Ring of lower efficiency at edge of hole at KIT
 - Not seen for focussed PS beam
 - Under investigation (see slides later)



Efficiency Sensor Maps

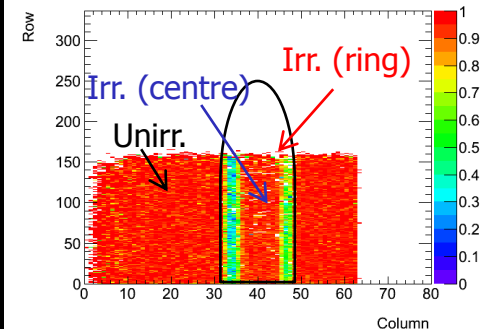
Noisy and dead pixels masked



Measurement Summary and Efficiency Results (Absolute Values)

Non-Uniform Irradiation	Unirr. Reference	PS Focussed	KIT Hole (circ.)	KIT Hole (slit)	
Φ [$10^{15} n_{eq}/cm^2$]	Unirr.	4.0 (max)	1.8	3.3	3.6
Sample	CNM 55	CNM 57	FBK 12_02_08	CNM S5-R7	CNM S3-R5
Edge	Regular	Regular	Regular	Slimmed	Slimmed
Threshold [ke]	3	1.7	2	2	3
ToT at 20 ke	10	10	~11	~5	~8
SingleSmall Hits Rejected	No	No	No	Yes	Yes
Eff _{max} (unirr) [%]	99	99	98	95	94
Eff _{max} (irr,centre) [%]	-	98	97	94	93
Eff _{max} (irr,ring) [%]	-	-	70	90	58

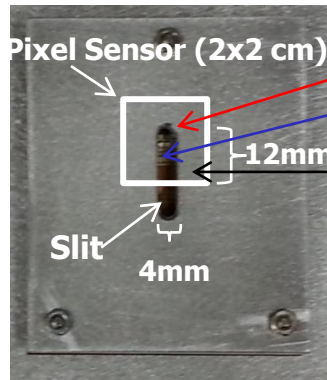
Device types, irradiation and measurement conditions vary!



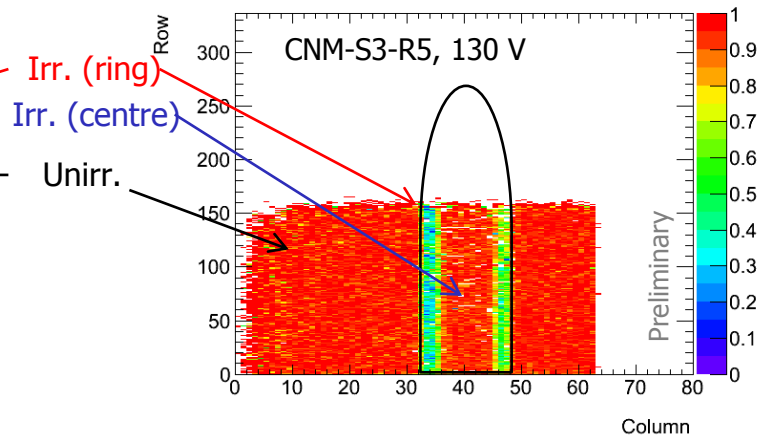
- 3-4% lower efficiency of 2 CNM devices irradiated at KIT (both unirr. and irr. area) is **artifact!**
 - Chip register HitDiscCnfg =2 (0 for other meas.) → Single small hits (ToT<3) rejected (good for time-walk correction, but usually test beam analyses take all hits into account)
 - Especially large effect in combination with low ToT tuning (verified with source scans: 5-20% eff. loss possible)
- Despite partly unfavourable settings: ≥ 93% in **irr. part (centre)** achieved (≥ 97% for favourable settings)
- Irradiated part (centre)** within 1% as efficient as unirradiated part
- Significantly lower eff. in **ring of irr. part**

Investigation of Low-Efficiency Ring

5 mm Al shields:

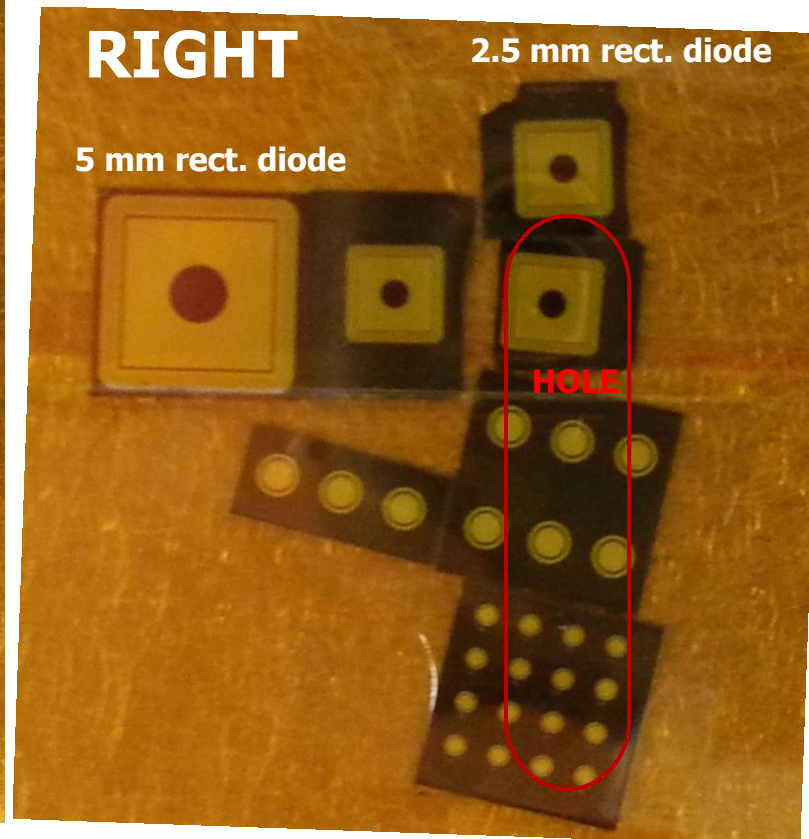
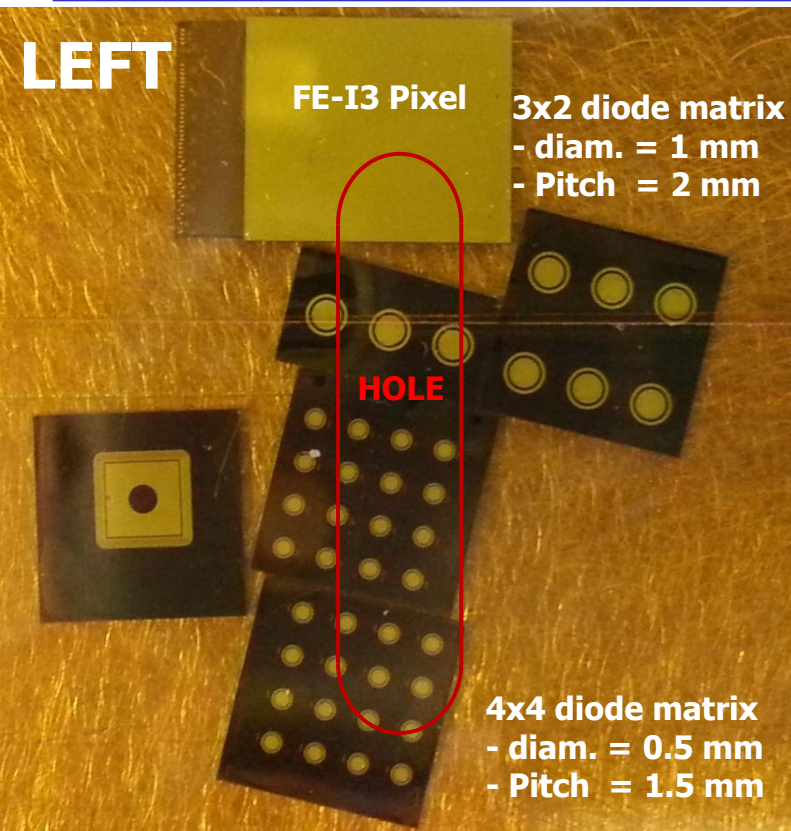


Pixel-Sensor Efficiency Map



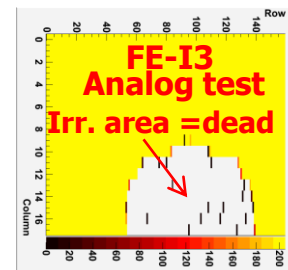
- Effect of irradiation method with Al shield (possibly higher effective fluence)?
 - Discussed at last RD50 workshop
 - Scattering of p at edge of Al shield → loose energy → much more damaging
- Or real effect of sharply non-uniformly irradiated devices?
 - Sensor effect?
 - Transition region between highly irradiated Si and unirradiated Si
→ huge gradient of defect density and current → maybe leads to lower el. field?
 - Chip effect?

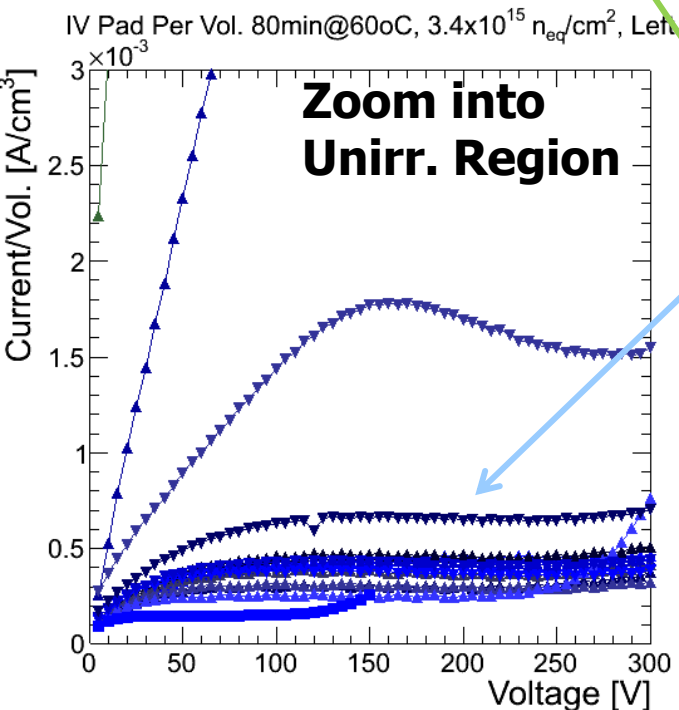
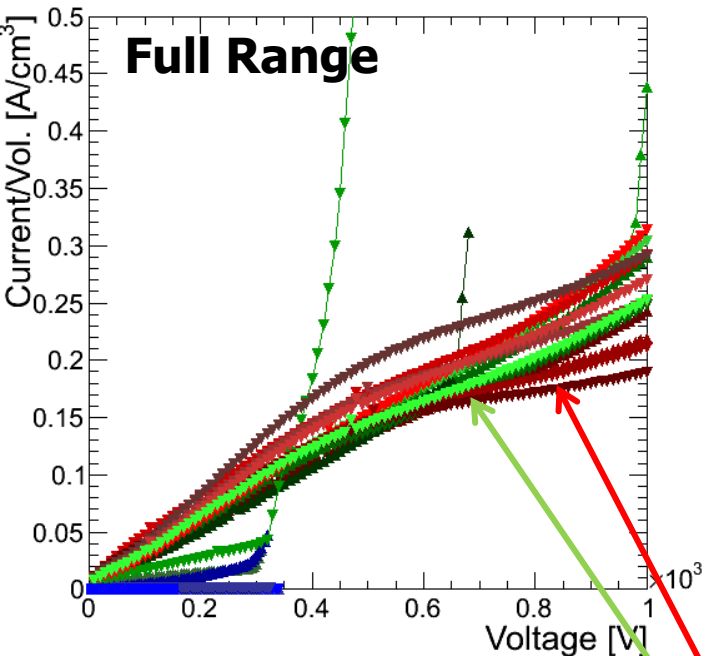
Position-Resolved Dosimetry



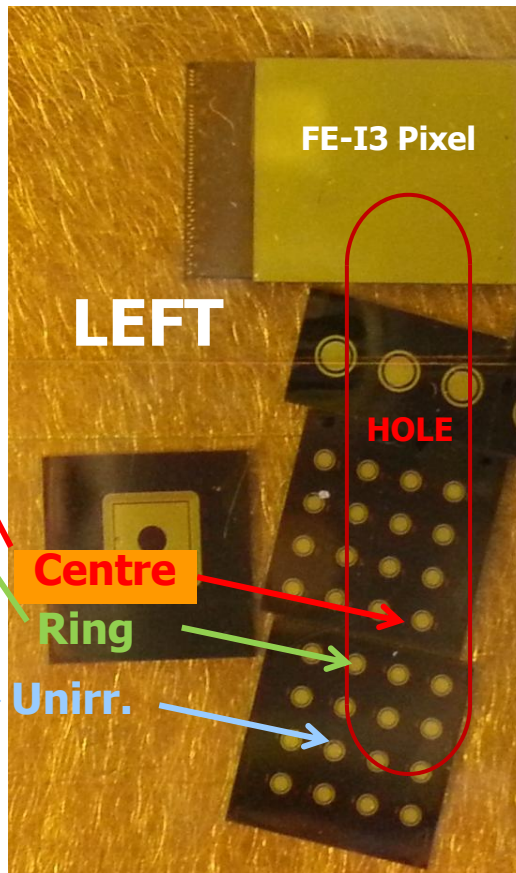
**Thanks to
CNM
(Giulio,
Marta,
Virginia)
for
providing
diodes,
setup and
help!**

- Multi-device approach (diodes: n-type STFZ, $d=300 \mu\text{m}$)
- Irradiation under same slit-like Al masks ("left" and "right") as pixel irradiation at KIT
 - Intended: $5\text{-}10 \times 10^{13} n_{\text{eq}}/\text{cm}^2$ (FE-I3 only specified up to $<10^{15} n_{\text{eq}}/\text{cm}^2$, reliable plateau for CV/IV)
 - Obtained: $3.4 \times 10^{15} n_{\text{eq}}/\text{cm}^2$ (FE-I3 dead in irr. area, no CV/IV plateau in irr. area)



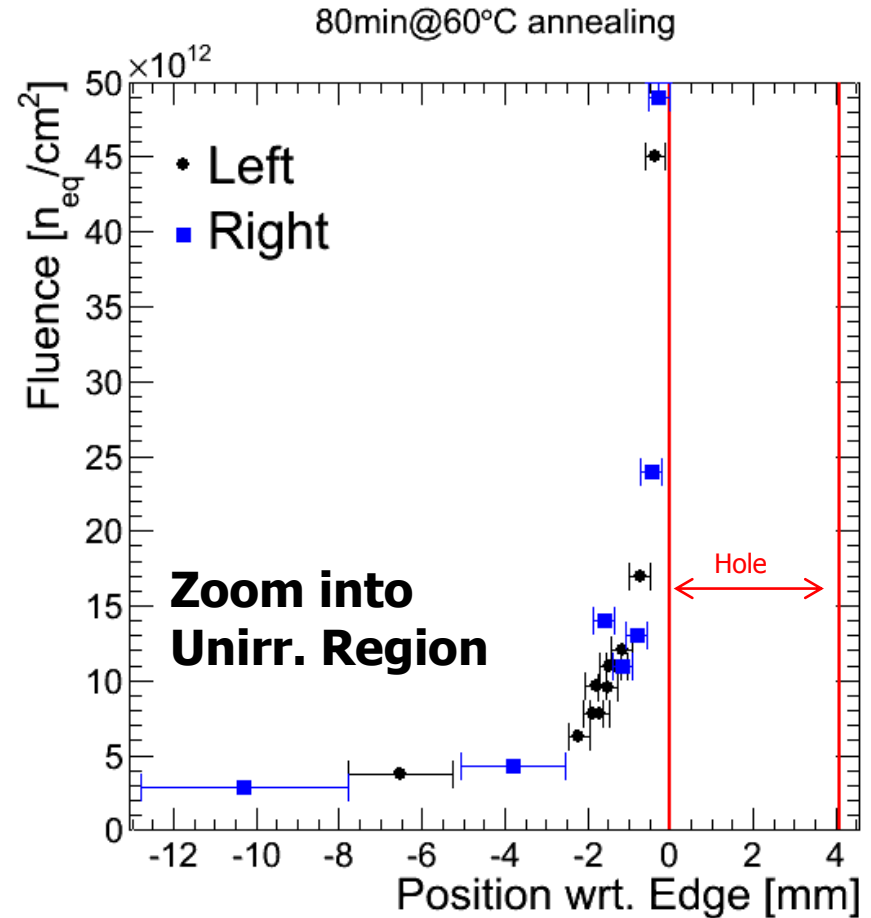
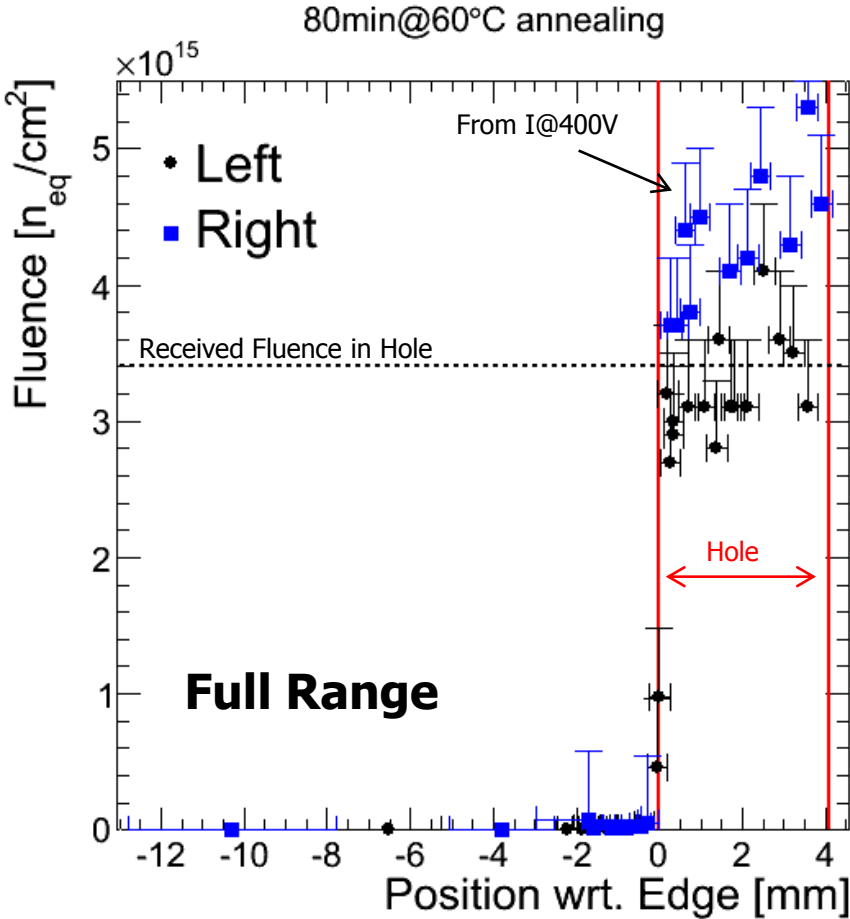


IV



- Measured at 20 °C
- 3x2-matrix diodes excluded (GR not contactable)
- No real plateau for irradiated diodes, but kink at 400-600 V → in the following I/V(400 V) for fluence calculation
- Plateau for most unirradiated ones
- No significant difference between **centre** and **edge** of irradiated region
- If only fraction of area has been irradiated, leakage current scales approx. with same fraction

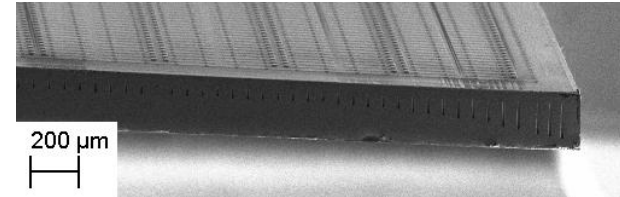
Fluence vs. Position wrt. Edge



- x error bars = extension of diode; upper y error bar to indicate lack of plateau; $\alpha = 4 \times 10^{17}$ A/cm
- No significant difference between **centre** and **edge** of irr. region; consistent with received fluence
- Substantial fluence ($\sim 10^{12} - 10^{13}$ cm $^{-2}$) also **under Al mask**; higher the closer to the hole

Conclusions

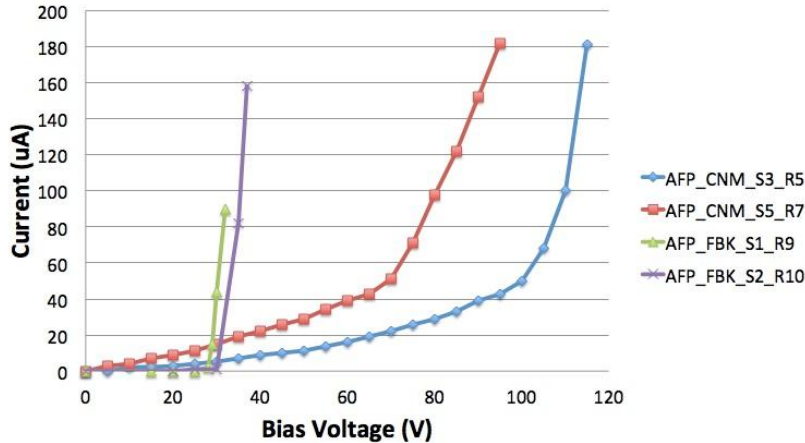
- Slim-edge and non-uniformly irradiated 3D AFP sensors studied
 - Inactive pixel-sensor region highly reduced (to 100-180 μm) without impact on efficiency
 - Without guard ring even efficient beyond last pixel
 - High efficiency achievable in centre of irradiated part at high- μ fluence (100 fb^{-1})
 - $\geq 97\%$ for all devices with optimal tuning and parameter setting
 - Low efficiency at edge of irradiated hole
 - Position-resolved dosimetry shows no hint of higher fluence at edge (at least not from I_{leak})
 - For approved low- μ run (100 pb^{-1}): 3 orders of magnitude less \rightarrow relaxed conditions
- Outlook:
 - Charge-collection measurements on dosimetry-diodes
 - New non-uniform irradi. at KIT with lower fluence and bare sensor/chip + planar FE-I3
 - Simulation of non-uniformly irradiated sensor
 - CNM AFP production run with 12 wafers expected to end soon



BACKUP

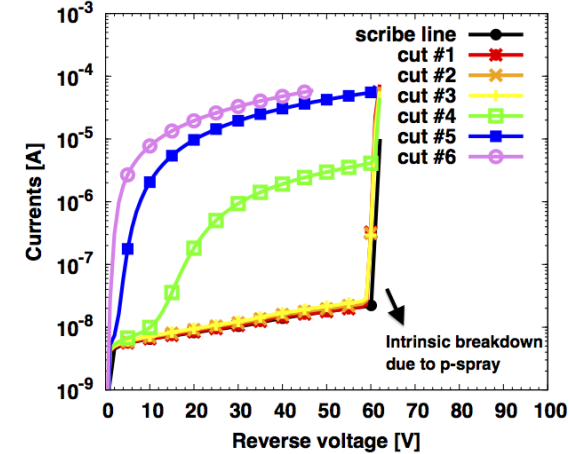
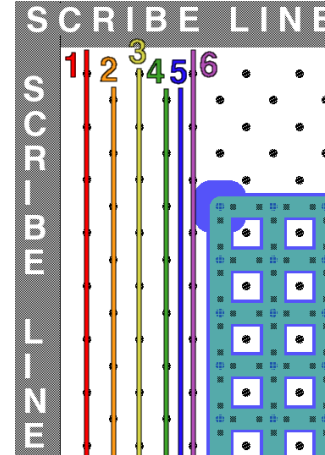
Current and Noise

IV of sensors used here (2 FBK, 2 CNM):
normal for used sensor-quality class

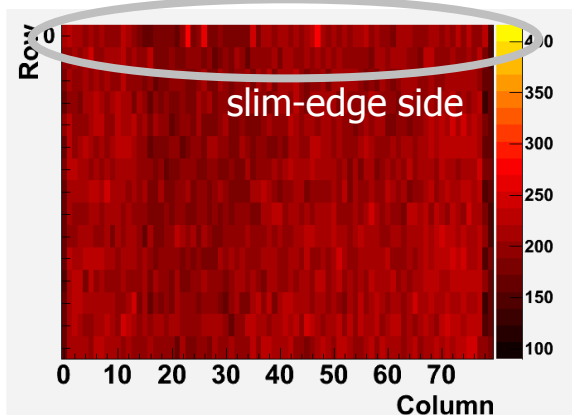


Previous study on FBK sensors:
IV unaffected up to 100 μm cut line

M. Povoli et al., JINST 7 (2012) C01015



Noise of CNM_S3_R5

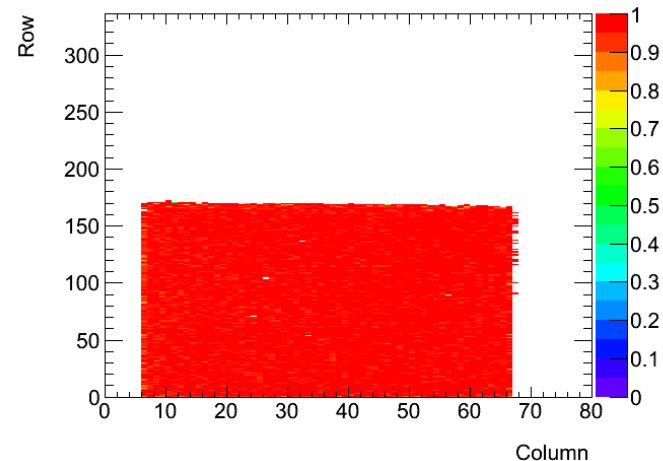


- No anomalous current and noise after edge-slimming to 100-180 μm

Efficiency of Slim-Edge Sensors in Test Beam

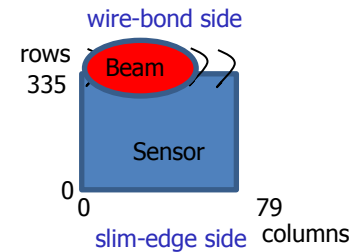
- DESY II Test beam: 4 or 5 GeV electrons
- ACONITE telescope (EUDET type)
- Normal incidence
- 1 reference IBL sensor,
4 slimmed-edge AFP sensors
- Average efficiency after slimming (97-99%)
comparable to IBL reference
→ what about edges?

Thanks to all test beam participants,
esp. I. Rubinskiy (DESY), D. Pohl (Bonn),
O. Korchak (Prague), Sh. Hsu (Washington)

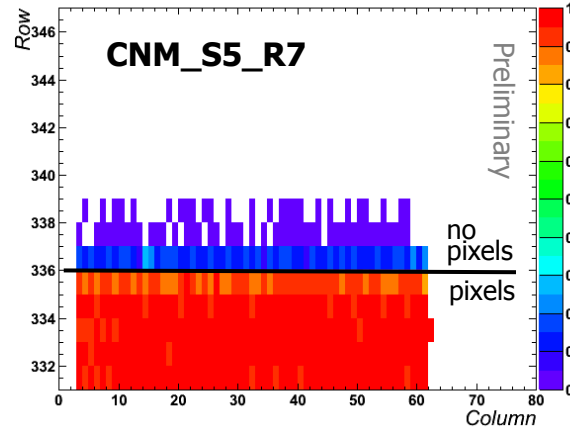


	DUTs				
Sample	CNM-55 (Refer.)	CNM_S3_R5	FBK_S5_R10	CNM_S5_R7	FBK_S1_R9
Edge	Regular	Slimmed	Slimmed	Slimmed	Slimmed
Bias [V]	30	30	20	30	20
Threshold [ke]	2.8	1.9	2.0	2.0	2.0
Efficiency	98-99%	98.3%	98.6%	96.9%	98.0%

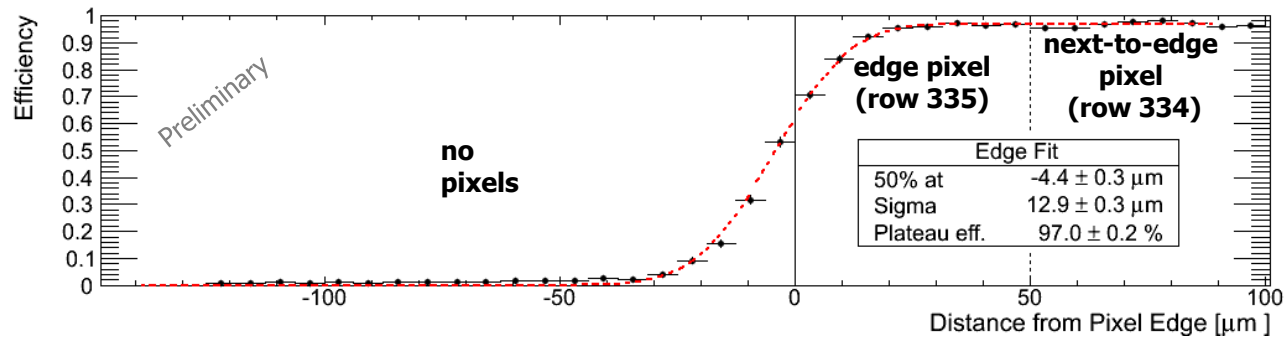
Regular Unslimmed Edge (Top Side)



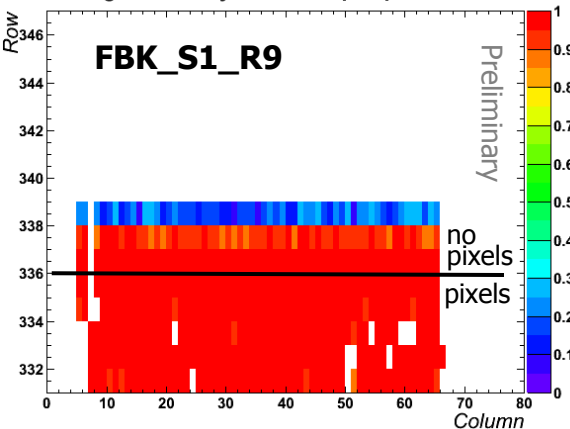
Y Edge Efficiency Sensor Map Top



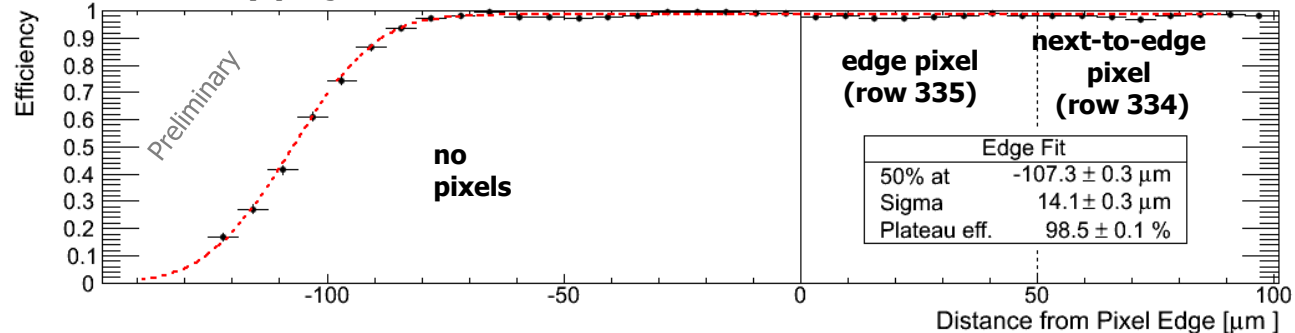
Efficiency projection



Y Edge Efficiency Sensor Map Top



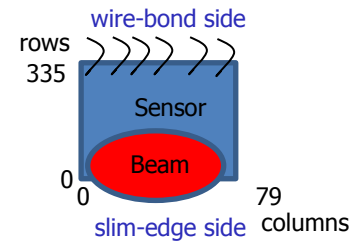
Efficiency projection



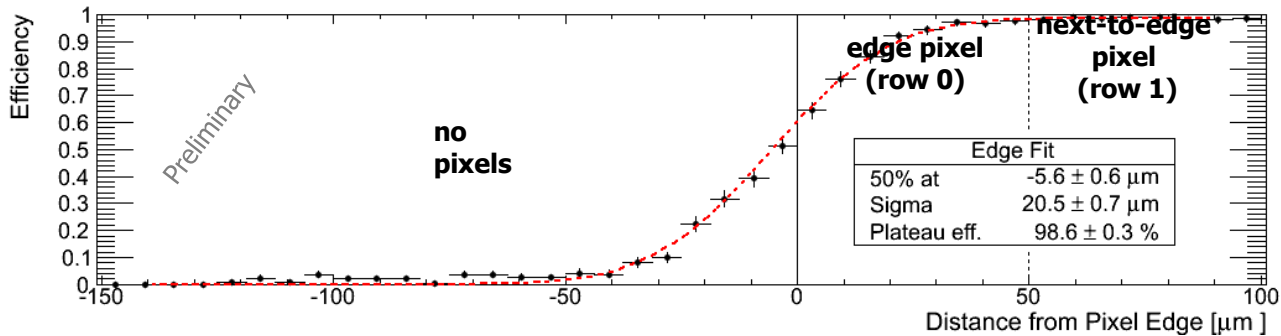
- Efficiency stable up to last pixel
 - Smearing due to beam telescope resolution
 - For FBK even $\sim 100 \mu\text{m}$ beyond (active edge due to absence of guard ring); a bit noisy/hot pixels \rightarrow masked

Slim Edge (Bottom Side)

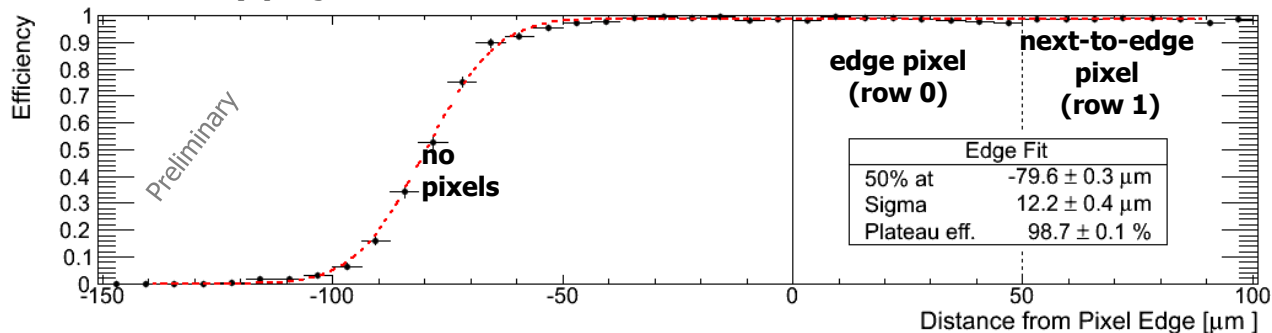
Other devices



Efficiency projection CNM_S3_R5

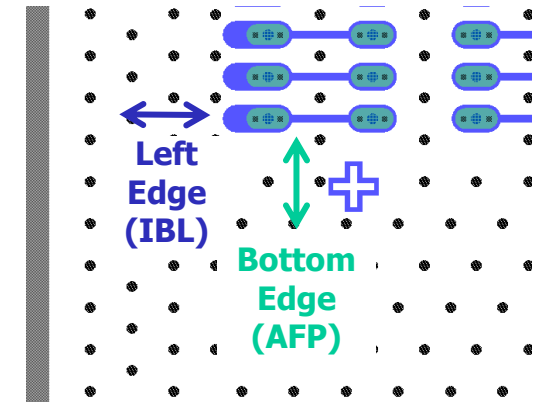
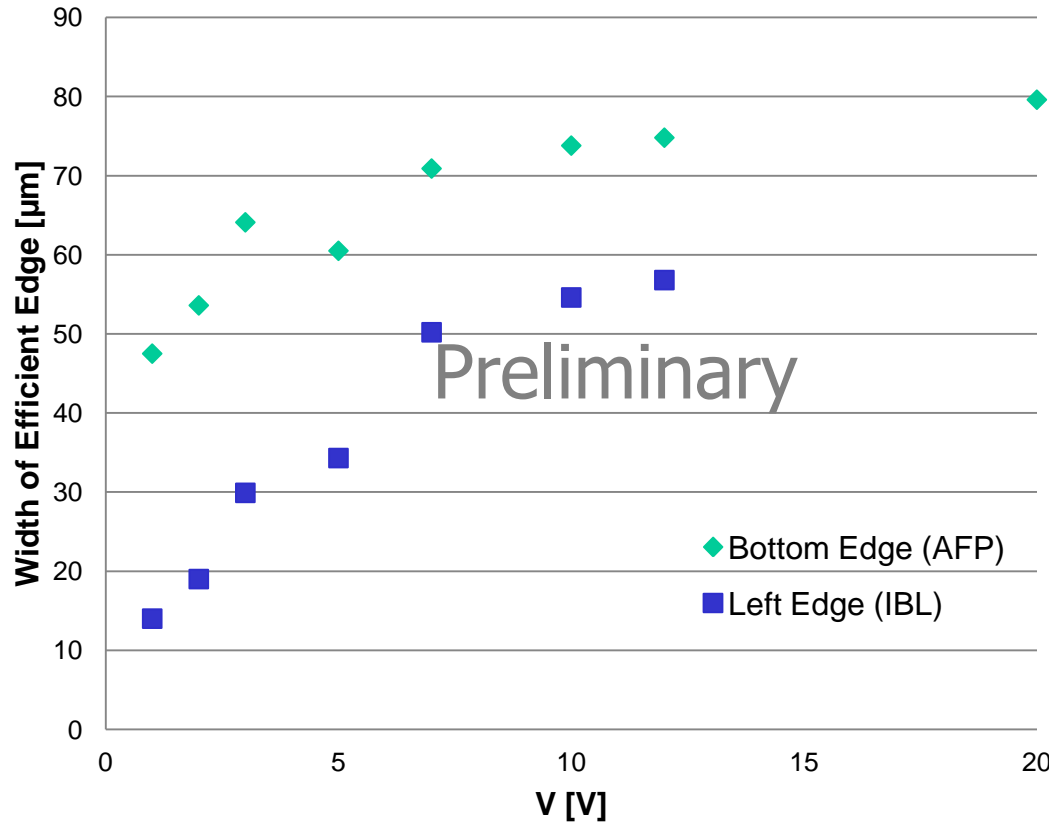
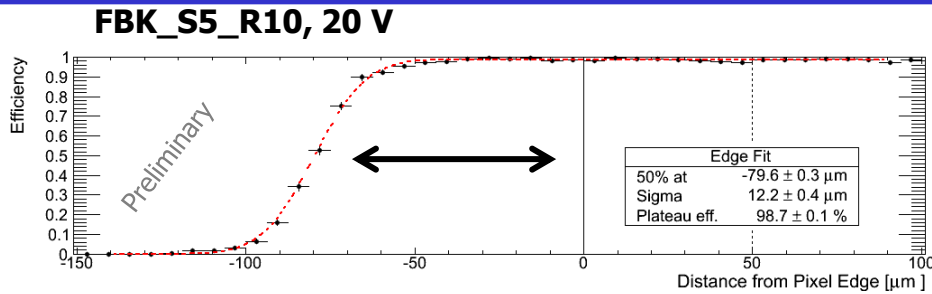


Efficiency projection FBK_S5_R10



- Efficiency stable up to last pixel
 - For FBK even $\sim 85 \mu\text{m}$ beyond (active edge due to absence of guard ring); a bit noisy/hot pixels \rightarrow masked
- \rightarrow same behaviour as for non-slimmed edge!

Development of Efficient Edge in FBK Sensor with Voltage



- Width of efficient edge increases with voltage (depletion zone increases)
- Saturation between first and second guard line beyond last pixel
- **Bottom edge** has larger width of efficient edge than **left edge**

Electrical Characteristics

- Not optimal sensors from beginning (IBL spares)
 - Merged/disconnected bump bonds, partly low V_{BD}

FBK_12_02_08

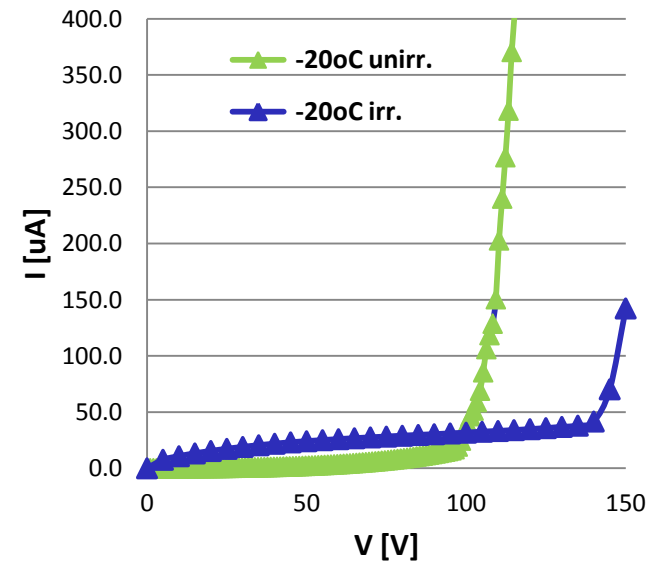
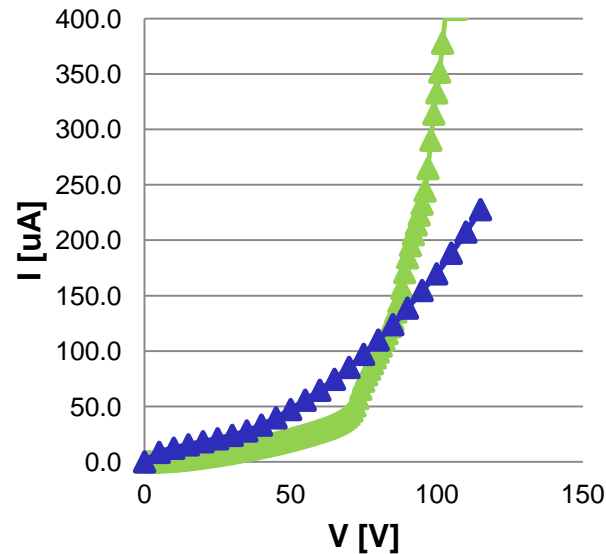
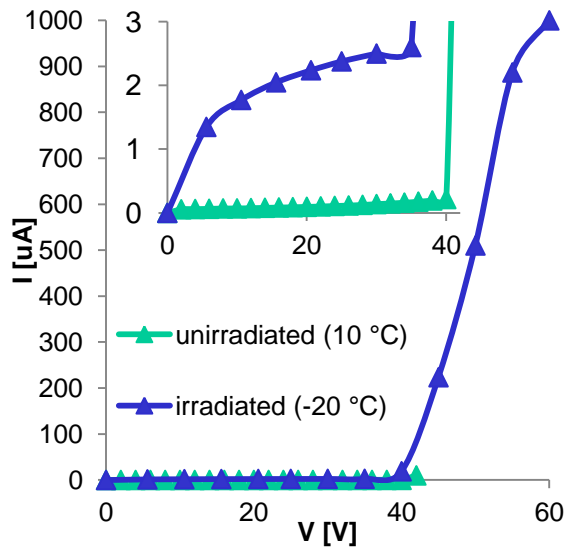
CNM_S5_R7

CNM_S3_R5

- $V_{BD} \sim 40$ V before and after irradi.
- Able to bias up to 58 V

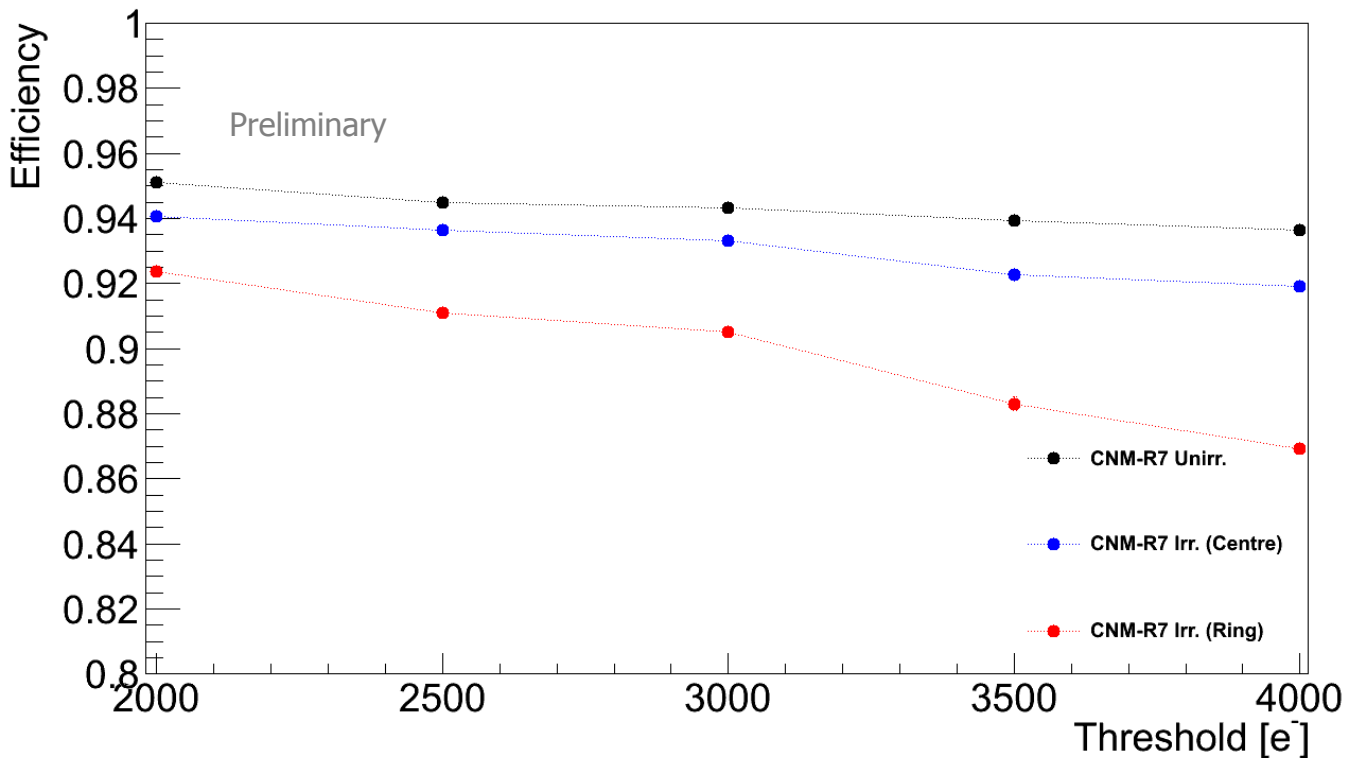
- Soft BD
- Lower I after irr. at high V

- Shift of V_{BD} to higher V
- Lower I after irr. at high V



Efficiency vs. Threshold

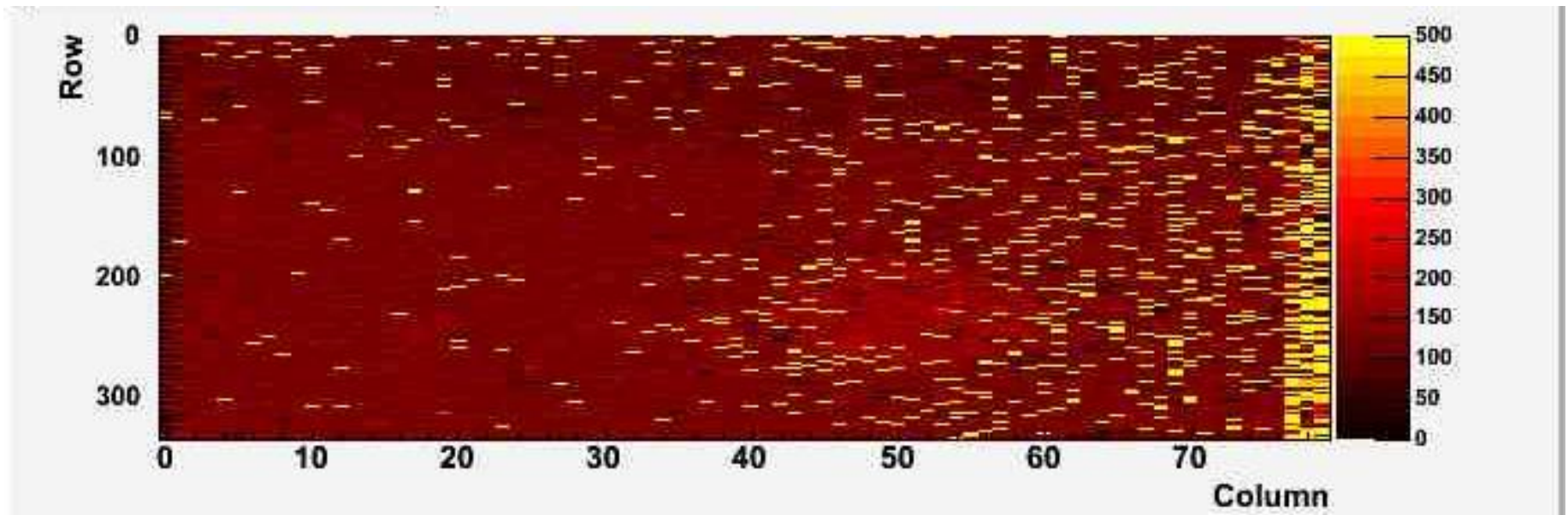
- Improvement of 1% per 1000e reduction of threshold for unirradiated and irradiated (centre) area
- Even more for higher irradiated ring



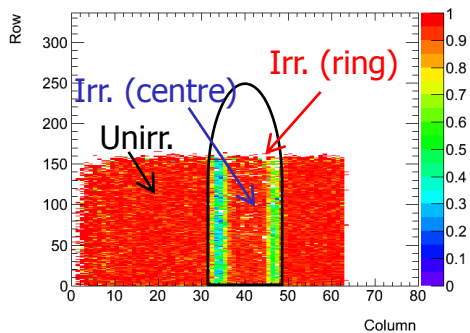
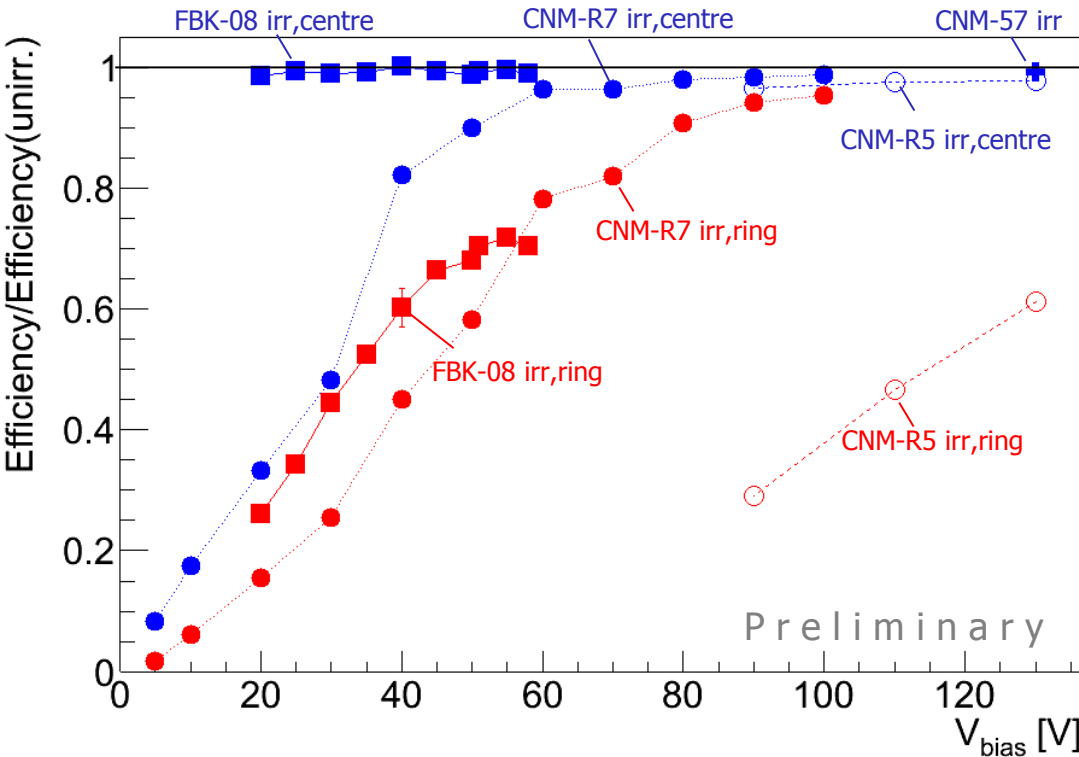
Noise of irradiated sensor

- Noise outside irradiated region ~ 130 e
- Noise inside irradiated region slightly higher (by about 10-20e)

FBK-12-02-08, 50 V

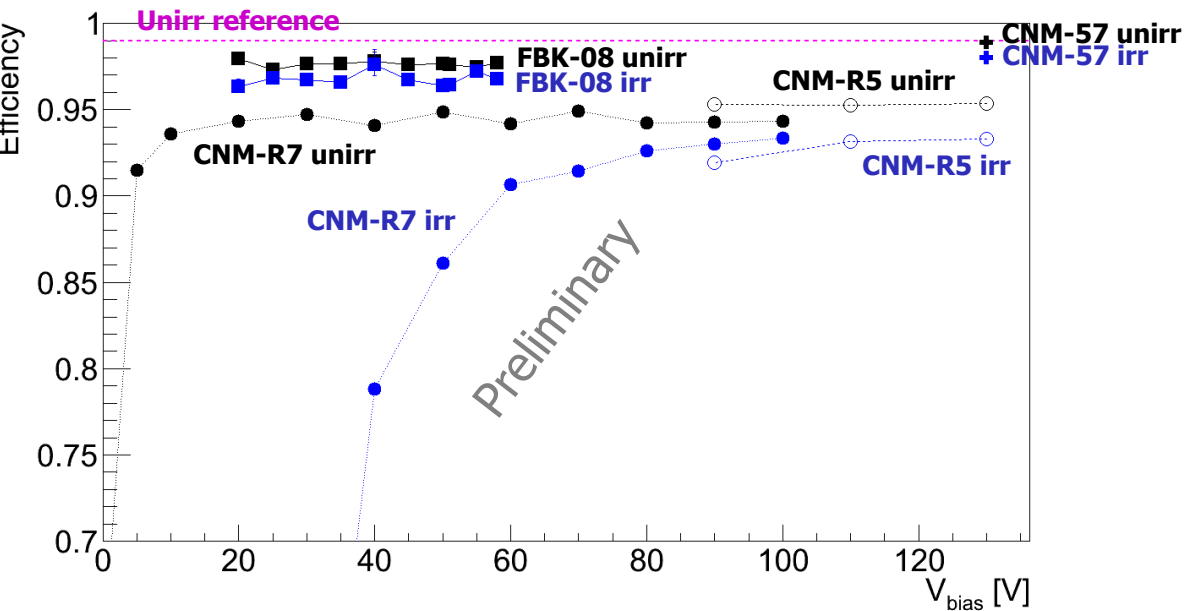


Efficiency/Efficiency(unirr.)



- For better comparison of measurements under different conditions:
Ratio of efficiency/efficiency(unirr)
- BUT: Curve might change for CNM-R5/7 if measured with HitDiscCnfg = 0 (effect on lower eff. is larger)
- Irradiated part (**centre**)
 - For FBK-08 ($1.8 \times 10^{15} n_{eq}/cm^2$) plateau reached already below 20V
 - For CNM-R7 ($\sim 3.3 \times 10^{15} n_{eq}/cm^2$) plateau reached at about 60 V
- Irradiated part (**ring**)
 - All behave differently
 - FBK seems to saturate at 50 V at $\sim 70\%$
 - CNM-R7 saturates at 90-100 V at $\sim 90\%$
 - CNM-R5 much lower, but still steeply increasing at 130 V (60%)

Efficiency



- Irradiated area (centre) almost as efficient as unirr. area
- Irradiation through hole (KIT): offset for CNM devices
 - Both unirr. and irr. area
 - Note different fluence, irr. area, threshold, edge
 - Threshold of 2 ke gives 1% more
 - Problem with tuning? Non-uniform eff. even in unirr. Area
- For all devices: eff. $\geq 93\%$
- Highest eff. for focussed-beam irradiation with CNM-57: 98% in irr. area
- Possibly improvable by tilting sensor (15° under study)

Non-Uniform Irradiation	Unirr. Reference	PS Focussed	KIT Hole (circ.)	KIT Hole (slit)	
Φ [$10^{15} n_{eq}/cm^2$]	Unirr.	4.0 (max)	1.8	3.3	3.6
Sample	CNM 55	CNM 57	FBK 12_02_08	CNM S5-R7	CNM S3-R5
Edge	Regular	Regular	Regular	Slimmed	Slimmed
Threshold [ke]	3	1.7	2	3 (2)	3
Eff _{max} (unirr) [%]	99	99	98	94 (95)	94
Eff _{max} (irr) [%]	-	98	97	93 (94)	93